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April 2013



SEMICONDUCTOR

FIN1049 LVDS Dual-Line Driver with Dual-Line Receiver

Features

- Greater than 400 Mbps Data Rate
- 3.3 V Power Supply Operation
- Low Power Dissipation
- Fail-Safe Protection for Open-Circuit Conditions
- Meets or Exceeds TIA/EIA-644-A LVDS Standard
- 16-pin TSSOP Package Saves Space
- Flow-Through Pinout Simplifies PCB Layout
- Enable/Disable for all Outputs
- Industrial Operating Temperature Range: -40°C to +85°C

Description

This dual driver-receiver is designed for high-speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The driver accepts LVTTL inputs and translates them to LVDS outputs. The receiver accepts LVDS inputs and translates them to LVTTL outputs. The LVDS levels have a typical differential output swing of 350 mV, which provides for low EMI at ultra-low power dissipation even at high frequencies. The FIN1049 can accept LVPECL inputs for translating from LVPECL to LVDS. The En and Enb inputs are AND-ed together to enable / disable the outputs. The enables are common to all four outputs. A single-line driver and single-line receiver function is also available in the FIN1019.

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FIN1049MTCX	-40 to +85°C	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide	Tape and Reel
			1

Pin Configuration R_{IN1-} 16 EN R_{IN1+} • ROUT1 2 15 R_{IN2+} ROUT2 3 14 R_{IN2-} - GND 13 DOUT2-12 · V_{CC} 5 DOUT2+ 11 DIN2 6 DOUT1+ 10 · DIN1 7 9 ENb DOUT1-8 Figure 1. Pin Configuration

Functional Diagram

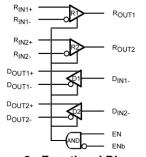


Figure 2. Functional Diagram

Pin Definitions

Pin #	Name	Description
2, 3	R _{IN1+} , R _{IN2+}	Non-Inverting LVDS Inputs
1, 4	R _{IN1-} , R _{IN2-}	Inverting LVDS Inputs
7, 6	D _{OUT1+} , D _{OUT2+}	Non-Inverting Driver Outputs
8, 5	D _{OUT1} -, D _{OUT2} -	Inverting Driver Outputs
16, 9	EN, ENb	Driver Enable Pins for All Outputs
15, 14	R _{OUT1} , R _{OUT2}	LVTTL Output Pins for R _{OUT1} and R _{OUT2}
10, 11	D _{IN1} , D _{IN2}	LVTTL Input Pins for D _{IN1} and D _{IN2}
12	Vcc	Power Supply (3.3 V)
13	GND	Ground

Function Table

Inp	Inputs		Outputs (LVTTL) Inpu		LVDS) ⁽¹⁾	Outputs (LVDS)	
EN	ENb	R _{OUT1}	R _{OUT2}	R _{INn+}	R _{INn-}	D _{OUTn+}	D _{OUTn} -
н	L	ON	ON			ON	ON
н	Н	Z	Z			Z	Z
L	Н	Z	Z			Z	Z
L	L	Z	Z	-		Z	Z
Н	L	Н	Н	Open (Fail-Safe	Current Condition		

Legend:

H=HIGH Logic Level

L=LOW Logic Level or OPEN

X=Don't Care

Z=High Impedance

Note:

1. Any unused receiver Inputs should be left open.

FIN1049 — LVDS Dual-Line Driver with Dual-Line Receiver

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage	-0.5	+4.6	V
V _{IN}	LVDS DC Input Voltage	-0.5	+4.6	V
V _{OUT}	LVDS DC Output Voltage	-0.5	+4.6	V
I _{OSD}	Driver Short-Circuit Current (Continuous)		10	mA
T _{STG}	Storage Temperature Range	-65	+150	°C
TJ	Max Junction Temperature		+150	°C
ΤL	Lead Temperature (Soldering, 10 Seconds)		+260	°C
ESD Human Body Model, JESD22-A114			≥ 7000	V
ESD	Machine Model, JESD22-A115		≥ 250	v

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V _{cc}	Supply Voltage	3.0	3.6	V
V _{ID}	Magnitude of Differential Voltage	100	V _{CC}	mV
T _A	Operating Temperature	-40	+85	°C

DC Electrical Characteristics

Over-supply voltage and operating temperature ranges, unless otherwise specified. All typical values are at $T_A=25^{\circ}C$ and with $V_{CC}=3.3$ V.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
LVDS Inp	ut DC Specifications (R _{IN1+} , R _{IN1-} , R _{IN2+} , R _{IN2}) See Figure 3 and Table 1				
V_{TH}	Differential Input Threshold HIGH	V _{CM} =1.2 V, 0.05 V, 2.35 V		0	35	mV
V_{TL}	Differential Input Threshold LOW		-100	0		mV
V _{IC}	Common Mode Voltage Range	V_{ID} =100 mV, V_{CC} =3.3 V	$V_{ID}/2$		V _{CC} - (V _{ID} /2)	V
I _{IN}	Input Current	V _{CC} =0 V or 3.6 V, V _{IN} =0 V or 2.8 V			±20	mA
CMOS/ L\	/TTL Input DC Specifications (EN, ENb, DIN	11, D _{IN2})				
V _{IH}	Input High Voltage (LVTTL)		2.0		V _{CC}	V
VIL	Input Low Voltage (LVTTL)		GND		0.8	V
I _{IN}	Input Current (EN, ENb, D _{IN1} , D _{IN2} , R _{INx+} , R _{INx-})	V _{IN} =0 V or V _{CC}			±20	μA
VIK	Input Clamp Voltage	V _{IK} =-18 mA	-1.5	-0.7		V
LVDS Out	tput DC Specifications (D _{OUT1+} , D _{OUT1-} , D _{OUT}	2+, D _{OUT2} -)				
V _{OD}	Output Differential Voltage	See Figure 4	250	350	450	mV
ΔV_{OD}	Vod Magnitude Change from	R _L =100 Ω			35	mV
	Differential LOW-to-HIGH	Driver Enabled				
Vos	Offset Voltage	See Figure 4	1.125	1.250	1.375	V
ΔV_{OS}	Offset Magnitude Change from Differential LOW-to-HIGH				25	mV
I _{OS}	Short-Circuit Output Current	D _{OUT+} =0V & D _{OUT-} =0 V, Driver Enabled			-9	mA
I _{OSD}		V _{OD} =0 V, Driver Enabled			-9	mA
I _{OFF}	Power-Off Input or Output Current	V _{CC} =0 V, V _{OUT} =0 V or V _{CC}			±20	mA
I _{OZD}	Disabled Output Leakage Current	$\begin{array}{l} \mbox{Driver Disabled,} \\ \mbox{D}_{OUT+}=0 \mbox{ V or } V_{CC} \mbox{ or } \\ \mbox{D}_{OUT-}=0 \mbox{ V or } V_{CC} \end{array}$			±10	mA
CMOS/LV	TTL Output DC Specifications (R_{OUT1}, R_{OUT}	2)				
V _{OH}	Output High Voltage	I_{OH} =-2 mA, V_{ID} =200 mV	2.7			V
V _{OL}	Output Low Voltage	$I_{OL}=2$ mA, $V_{ID}=200$ mV			0.25	V
I _{OZ}	Disabled Output Leakage Current	Driver Disabled, R _{OUTn} =0 V or V _{CC}			±10	mA
I _{CC}	Power Supply Current ⁽²⁾	Drivers Enabled, Any Valid Input Condition			25	mA
I _{CCZ}	Power Supply Current	Drivers Disabled			10	mA
CIND	Input Capacitance	LVDS Input		3.0		pF
Соит	Output Capacitance	LVDS Output		4.0		pF
CINT	Input Capacitance	LVTTL Input		3.5		pF

Note:

2. Both driver and receiver inputs are static. All LVDS outputs have 100 Ω load. None of the outputs have any lumped capacitive load.

AC Electrical Characteristics

Over-supply voltage and operating temperature ranges, unless otherwise specified. All typical values are at $T_A=25^{\circ}C$ and with $V_{CC}=3.3$ V.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Switching	Characteristics - LVDS Outputs				I.	
t PLHD	Differential Propagation Delay LOW-to-HIGH	See Figure 5, Figure 6			2	ns
t _{PHLD}	Differential Propagation Delay HIGH-to-LOW				2	ns
t _{TLHD}	Differential Output Rise Time (20% to 80%)		0.2		1.0	ns
t _{THLD}	Differential Output Fall Time (80% to 20%)		0.2		1.0	ns
t _{SK(P)}	Pulse Skew t _{PLH} - t _{PHL}				0.35	ns
t _{SK(LH),} t _{SK(HL)}	Channel-to-Channel Skew ⁽³⁾				0.35	ns
t _{SK(PP)}	Part-to-Part Skew ⁽⁴⁾				1	ns
t _{PZHD}	Differential Output Enable Time, Z-to-HIGH	See Figure 7, Figure 8			6	ns
t _{PZLD}	Differential Output Enable Time, A-to-LOW				6	ns
t PHZD	Differential Output Disable Time, HIGH-to-Z				3	ns
t _{PLZD}	Differential Output Disable Time, LOW-to-Z		N.,		3	ns
f _{MAXD}	Maximum Frequency ⁽⁵⁾	See Figure 5	200			MHz
Switching	Characteristics - LVTTL Outputs					
t _{PHL}	Propagation Delay HIGH-to-LOW	Measured from 20% to 80% Signal	0.5	1.0	3.5	ns
t _{PLH}	Propagation Delay LOW-to-HIGH	V _{ID} =200 mV	0.5	1.0	3.5	ns
t _{SK1}	Pulse Skew	Distributed Load	0	35	400	ps
t _{SK2}	Channel-to-Channel Skew	$C_L=15 \text{ pF}$ and 50 Ω	0	50	500	ps
t _{SK3}	Part-to-Part Skew	R _L =1 kΩ	0		1	ns
t _{LHR}	Transition Time LOW-to-HIGH	V _{OS} =1.2 V	0.10	0.25	1.40	ns
t _{HLR}	Transition Time HIGH-to-LOW	See Figure 9, Figure 10	0.10	0.18	1.40	ns
t _{PHZ}	Disable Time HIGH-to-Z	See Figure 11, Figure 12	2.2	4.5	8.0	ns
t _{PLZ}	Disable Time LOW-to-Z		1.3	3.5	8.0	ns
t _{РZH}	Enable Time Z-to-HIGH		1.8	3.0	7.0	ns
t _{PZL}	Enable Time Z-to-LOW		0.9	1.4	7.0	ns
f _{MAXT}	Maximum Frequency ⁽⁶⁾	See Figure 9	200			MHz

Notes:

3. $t_{SK(LH)}$, $t_{SK(HL)}$ is the skew between specified outputs of a single device when the outputs have identical loads and are switching in the same direction.

 t_{SK(PP)} is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.

5. f_{MAXD} generator input conditions: $t_r=t_f < 1$ ns (10% to 90%), 50% duty cycle, 0 V to 3 V. Output criteria: duty cycle=45% / 55%, $V_{OD} > 250$ mV, all channels switch.

6. f_{MAXT} generator input conditions: $t_r=t_f < 1$ ns (10% to 90%), 50% duty cycle, $V_{ID}=200$ mV, $V_{CM}=1.2$ V. Output criteria: duty cycle=45% / 55%, $V_{OH} > 2.7$ V. $V_{OL} < 0.25$ V, all channels switching.

Required Specifications and Test Diagrams

Notes:

- 7. Electrostatic Discharge Capability: Human Body Model and Machine Model ESD should be measured using MIL-STD-883C method 3015.7 standard.
- 8. Latch-up immunity should be tested to the EIA/JEDEC Standard Number 78 (EIA/JESD78).

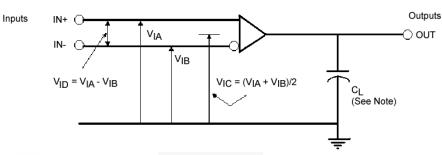


Figure 3. Differential Receiver Voltage Definitions Test Circuit

Note:

9. C_L=15 pF, includes all probe and jig capacitances.

Table 1.	Receiver Minimum and Maximum Input Threshold Test Voltages
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Applied	Voltages (V)	Resulting Differential Input Voltage (mV)	Resulting Common Mode Input Voltage (V)		
VIA	V _{IB}	V _{ID}	V _{IC}		
1.25	1.15	100	1.2		
1.15	1.25	-100	1.2		
V _{CC}	V _{CC} - 0.1	100	V _{CC} - 0.05		
V _{CC} - 0.1	V _{cc}	-100	V _{CC} - 0.05		
0.1	0.0	100	0.05		
0.0	0.1	-100	0.05		
1.75	0.65	1100	1.2		
0.65	1.75	-1100	1.2		
V _{CC}	V _{CC} - 1.1	1100	V _{CC} - 0.55		
V _{CC} - 1.1	V _{cc}	-1100	V _{CC} - 0.55		
1.1	0.0	1100	0.55		
0.0	1.1	-1100	0.55		

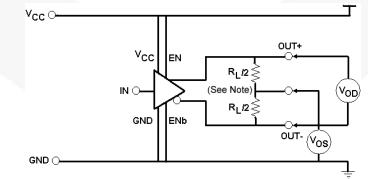
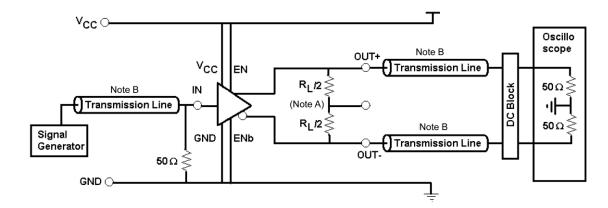


Figure 4. LVDS Output Circuit for DC Test

Note:

10. $R_L{=}100~\Omega.$

Required Specifications and Test Diagrams (Continued)

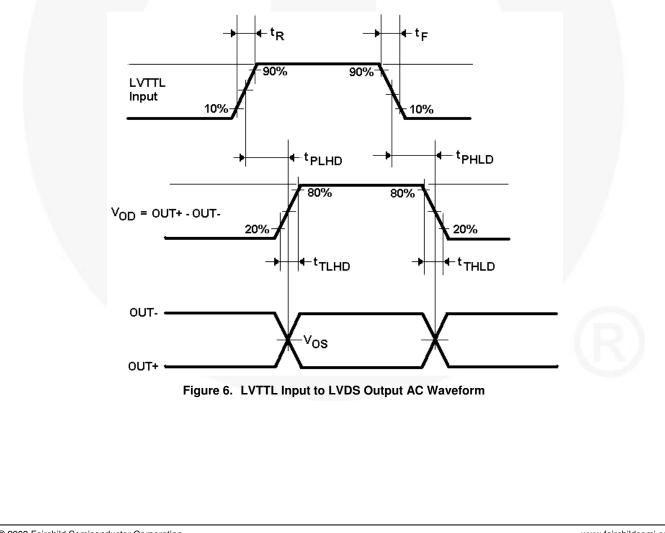


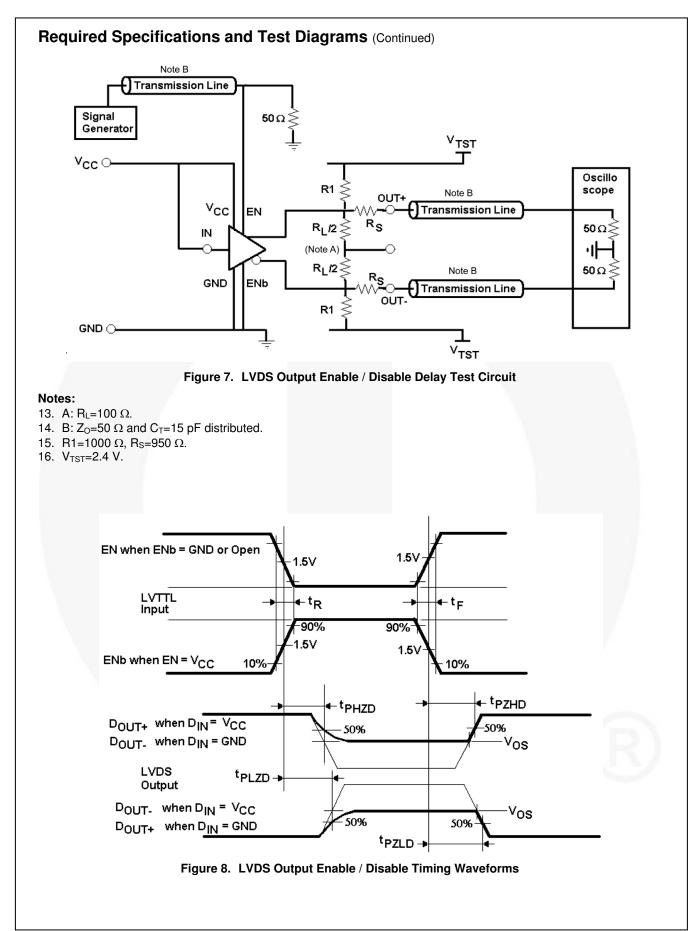


Notes:

11. A: R_L=100 Ω.

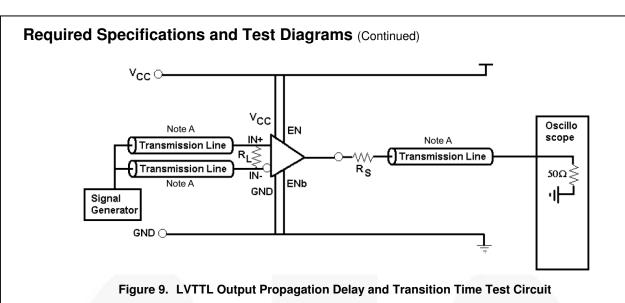
12. B: $Z_0=50 \Omega$ and $C_T=15 \text{ pF}$ distributed.





FIN1049 — LVDS Dual-Line Driver with Dual-Line Receiver

8



Notes:

- 17. A: $Z_0=50 \Omega$ and $C_T=15 pF$ distributed.
- 18. R_L =100 Ω and R_S =950 Ω .

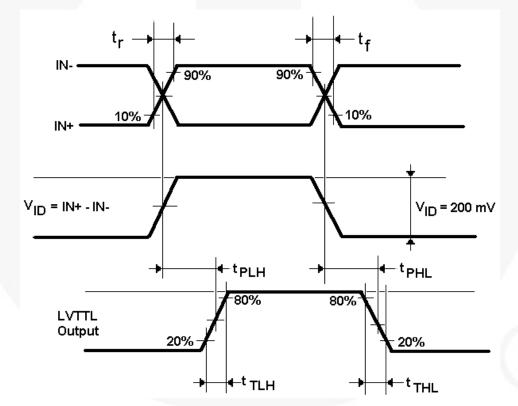
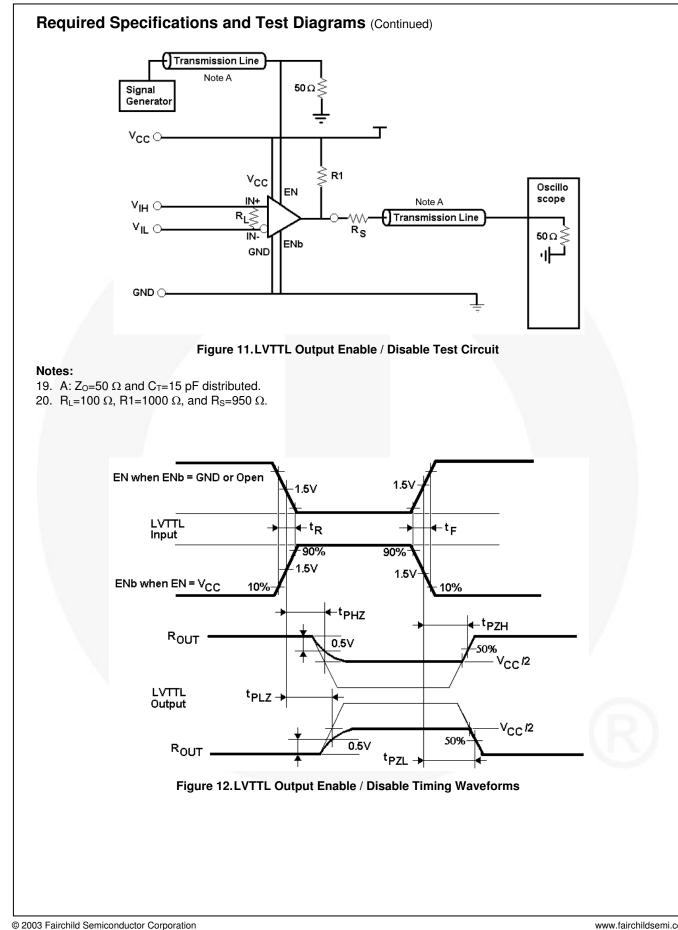
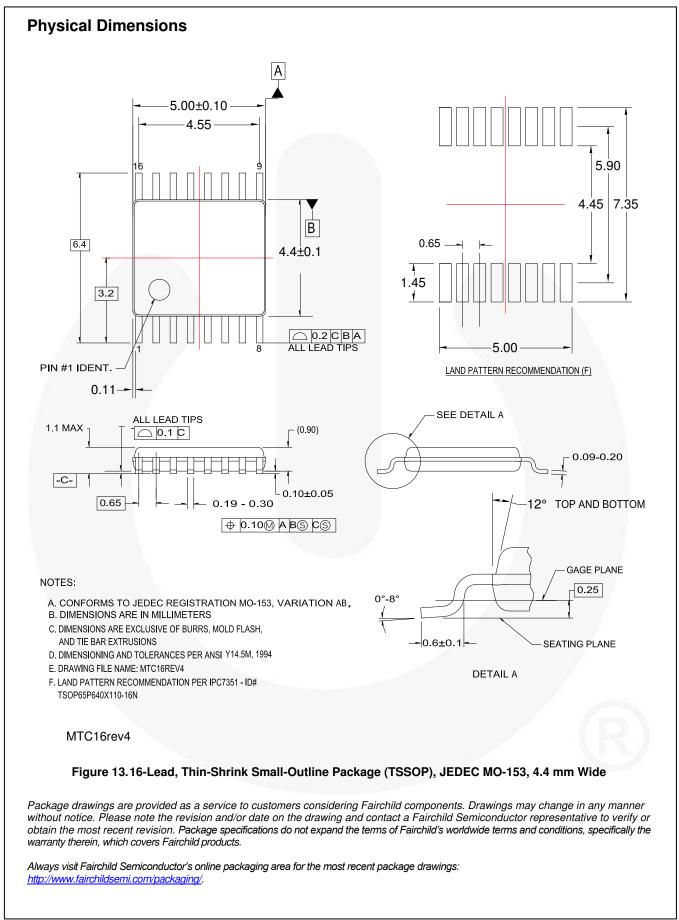


Figure 10. LVDS Input to LVTTL Output Propagation Delay and Transition Time Waveforms



10

FIN1049 • Rev. 1.0.3



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Rev. 164

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